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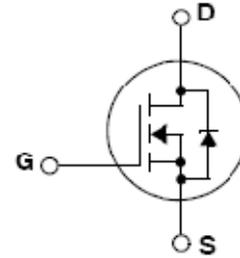
# BF92N60/BF92N60L/BF92N60R/BF92N60T

## 600V N-Channel MOSFET

### General Description

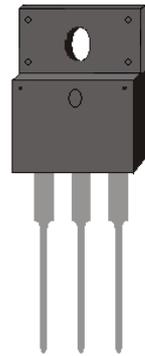
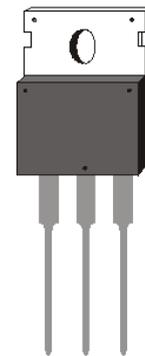
These N-Channel enhancement mode power field effect transistors are produced using DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction, electronic lamp ballasts based on half bridge topology.



### Features

- $V_{DS} = 600\text{ V}$
- $I_D = 2\text{ A}$
- $R_{DS(ON)} = 3.6\Omega$  TYP ( $V_{GS} = 10\text{ V}, I_D = 1\text{ A}$ )
- Low  $C_{RSS}$  (typical 4.5pF)
- Fast switching



TO220

TO220F

### Absolute Maximum Ratings

Symbol	Parameter	BF92N60R/ BF92N60T	BF92N60L	BF92N60	Unit
$V_{DS}$	Drain-Source Voltage	600			V
$I_D$	Drain Current(continuous)at $T_c=25^\circ\text{C}$	2			A
$I_{DM}$	Drain Current (pulsed) (Note1)	8			A
$V_{GS}$	Gate-Source Voltage	$\pm 30$			V
$E_{AS}$	SinglePulseAvalanche Energy (Note2)	130			mJ
$I_{AR}$	Avalanche Current (Note1)	2.0			A
$E_{AR}$	RepetitiveAvalancheEnergy (Note1)	5.4			mJ
$dv/dt$	PeakDiodeRecovery $dv/dt$ (Note3)	5			V/ns
$P_D$	Power Dissipation ( $T_c = 25^\circ\text{C}$ )	46	54	24	W
$T_{stg}$	Storage Temperature Range	-55 to +150			
$T_L$	Maximum Lead Temperature for Soldering Purpose	300			$^\circ\text{C}$

**Ordering Information**

Part Number	Package	Packaging
BF92N60	TO-220F	Tube
BF92N60L	TO-220	Tube
BF92N60R	TO-251	Tube
BF92N60T	TO-252	Tape&Reel

**Thermal Data**

Symbol	Parameter	TO-251/TO-252	TO-220F	TO-220	Unit
Rthj-case	Thermal Resistance Junction-case	2.7	5.3	2.3	°C /W
Rthj-amb	Thermal Resistance Junction-ambient	62.5	62.5	62.5	°C /W

**Electrical Characteristics(T<sub>c</sub> = 25°C)**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> =250uA V <sub>GS</sub> =0V	600			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V			10	uA
		V <sub>DS</sub> =600V, V <sub>GS</sub> =0V, T <sub>c</sub> =125°C			100	uA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	2.0		4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =1.0A		3.6	4.2	Ω
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =25V, f=1MHZ, V <sub>GS</sub> =0V		420		pF
C <sub>oss</sub>	Output Capacitance			40		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			4.5		pF
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =300V, I <sub>D</sub> =1A V <sub>GS</sub> =10V, R <sub>G</sub> =4.7 Ω (Note4,5)		11		ns
t <sub>r</sub>	Rise Time			9.5		ns
t <sub>d(off)</sub>	Turn-Off Delay Time			40		ns
t <sub>f</sub>	Fall Time			13		ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DD</sub> =480V, I <sub>D</sub> =2A V <sub>GS</sub> =10V (Note4,5)		12		nC
Q <sub>gs</sub>	Gate-Source Charge			3		nC
Q <sub>gd</sub>	Gate-Drain Charge			4		nC
V <sub>SD</sub> (*)	Forward On Voltage	I <sub>S</sub> =2A V <sub>GS</sub> =0V		0.8	1.2	V
T <sub>rr</sub>	Reverse Recovery Time	V <sub>DD</sub> =300V, I <sub>F</sub> =2A, di/dt=100A/us (Note4)		176		ns

**Notes:**

1. Repetitive Rating : Pulse width limited by maximum junction temperature
  2. L = 60mH, I<sub>AS</sub> = 2 A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25 Ω, Starting T<sub>J</sub> = 25°C
  3. I<sub>SD</sub> ≤ 2A, di/dt ≤ 200A/μs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C
  4. Pulse Test : Pulse width ≤ 300μs, duty cycle ≤ 2%
  5. Essentially independent of operating temperature
- (\*). Pulsed: Pulse duration



### Typical characteristics (25°C unless noted)

Figure 1 Output Characteristics

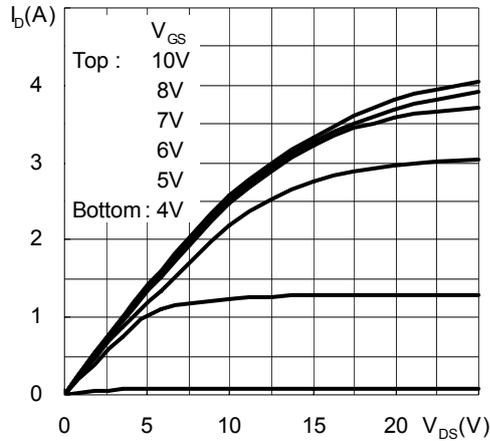


Figure 2 Transfer Characteristics

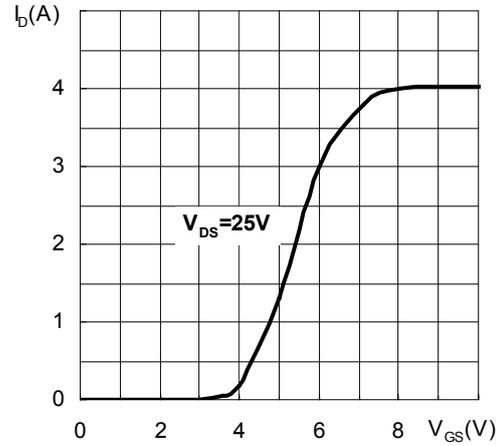


Figure 3 Normalized Threshold Voltage Vs Temperature

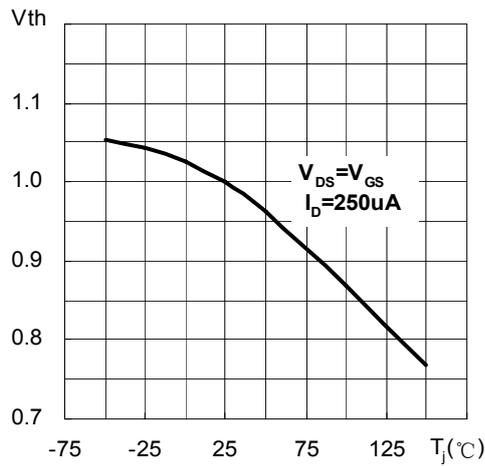


Figure 4 Normalized  $BV_{DSS}$  vs Temperature

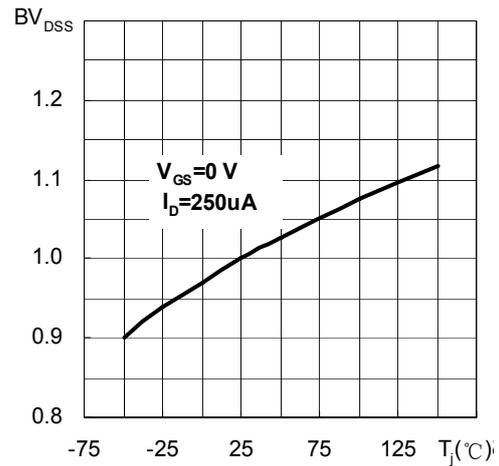


Figure 5 Normalized on Resistance vs Temperature

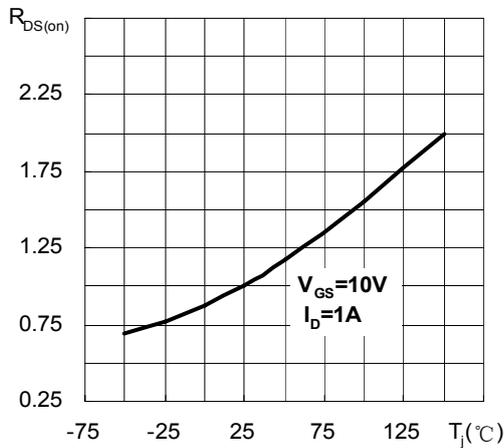


Figure 6 Source-Drain Diode Forward Characteristics

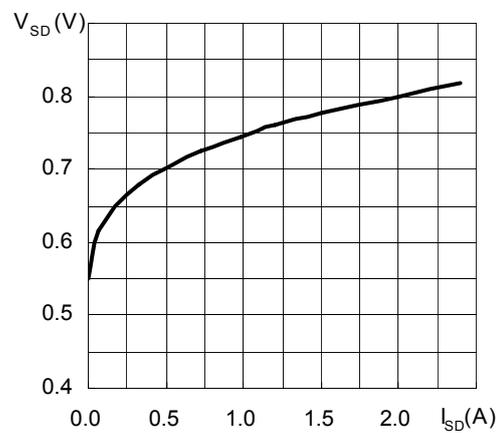




Figure 7 Capacitance

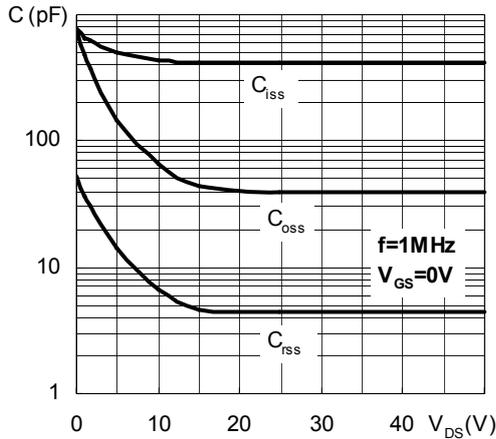


Figure 8 Gate Charge

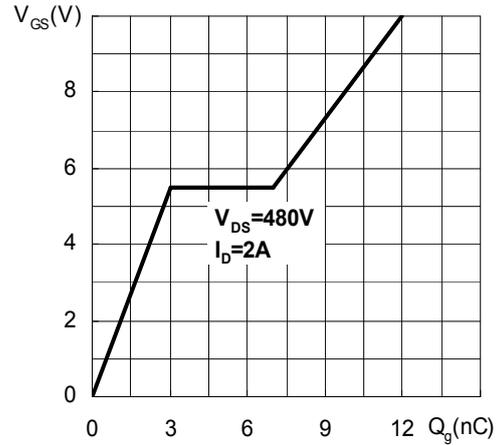


Figure 9-1 Maximum Safe Operating Area For BF92N60R/BF92N60T

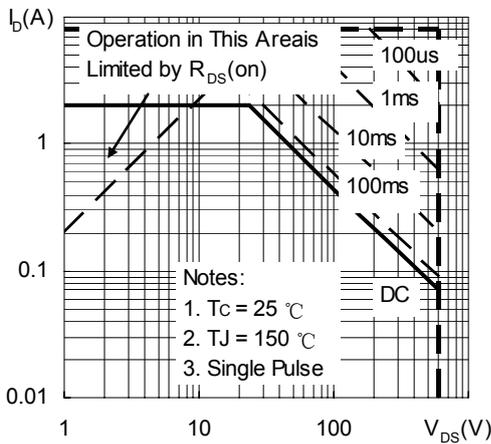


Figure 9-2 Maximum Safe Operating Area For BF92N60L

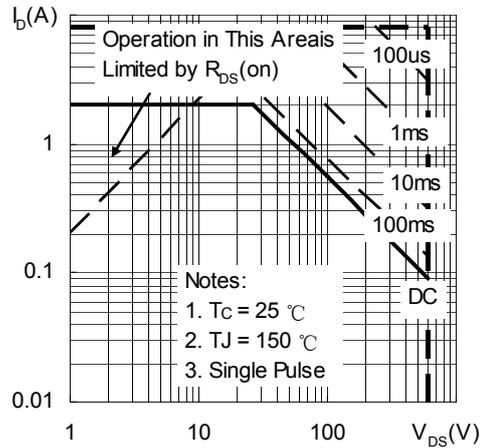


Figure 9-3 Maximum Safe Operating Area For BF92N60

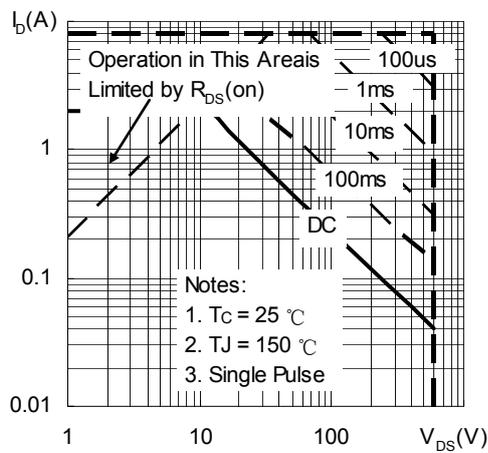


Figure 10 Maximum Drain Current vs Case Temperature

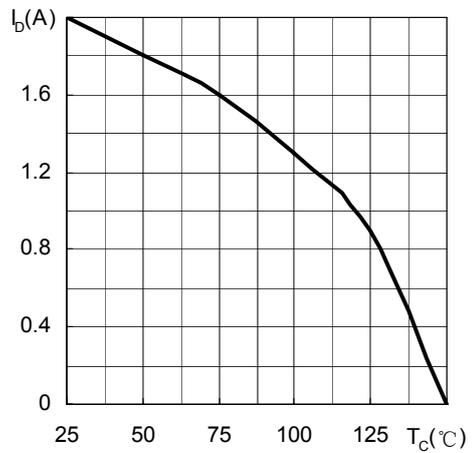


Figure 11-1 Maximum Transient Thermal Impedance For BF92N60R/BF92N60T

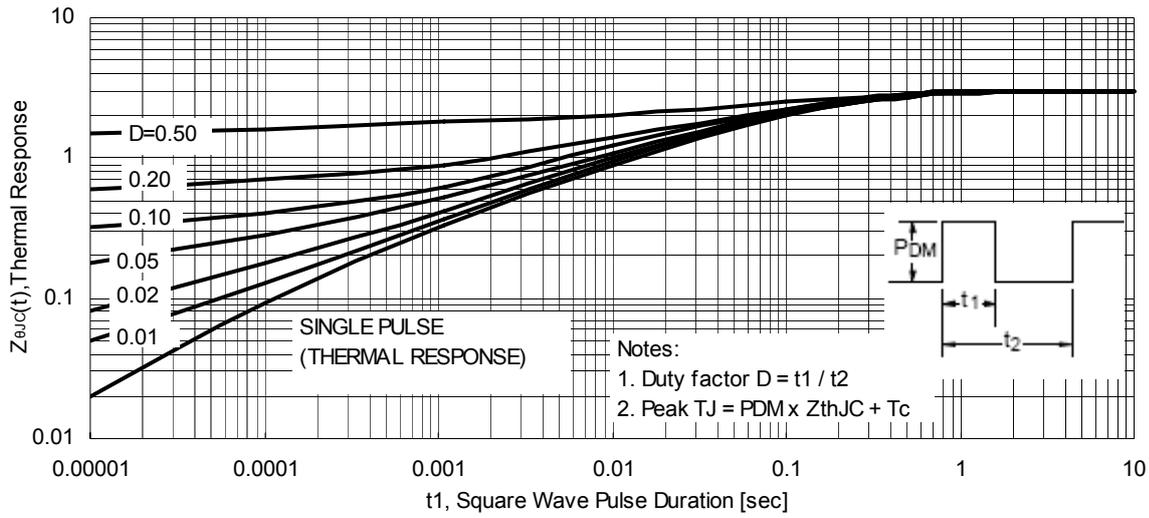


Figure 11-2 Maximum Transient Thermal Impedance For BF92N60L

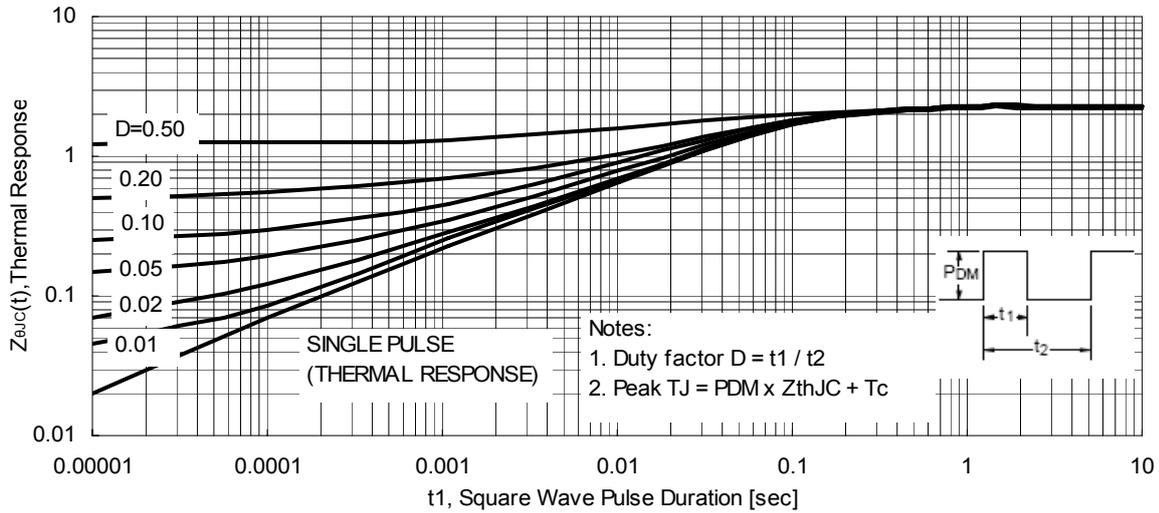
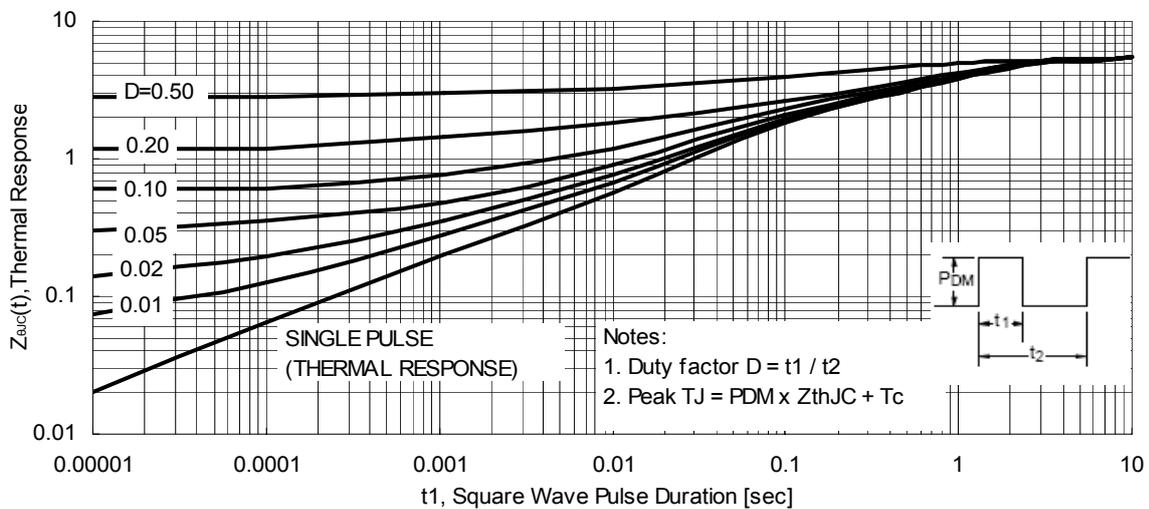
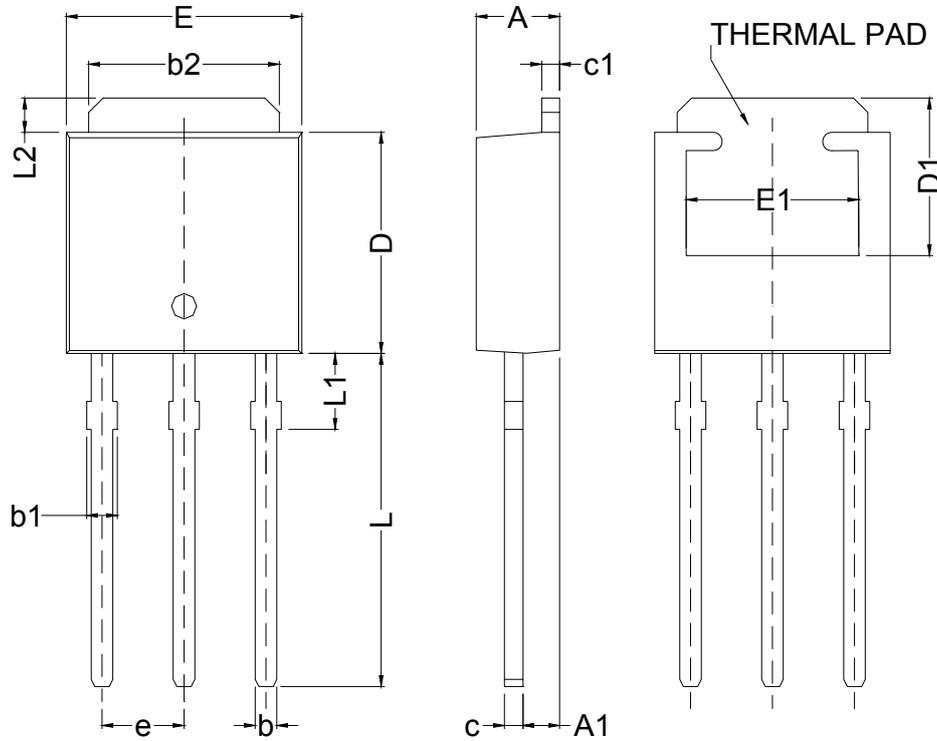


Figure 11-3 Maximum Transient Thermal Impedance For BF92N60



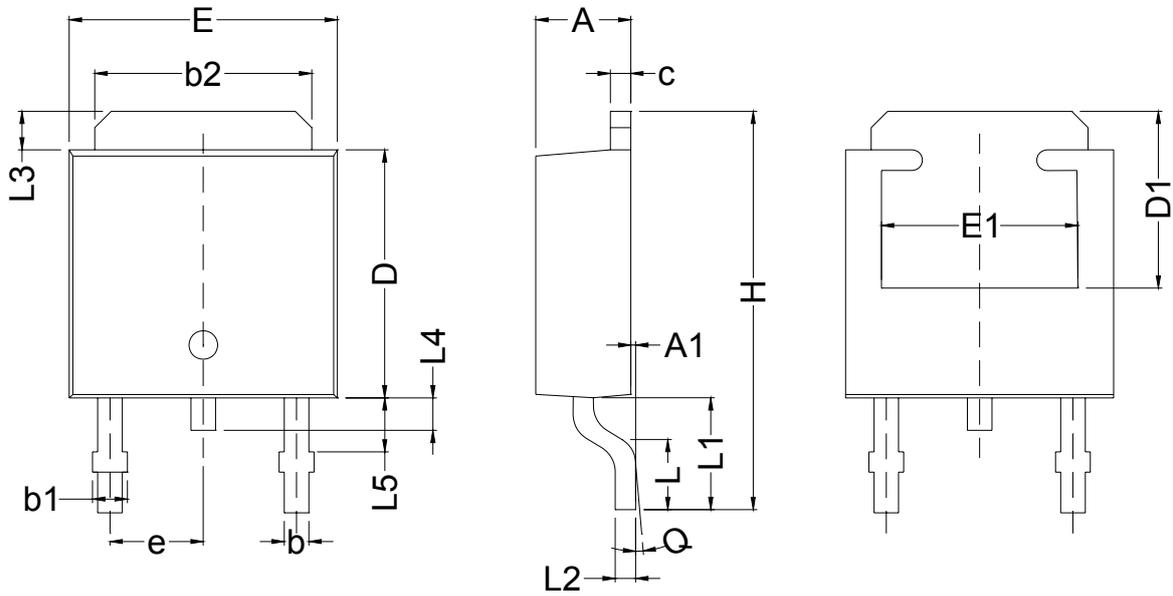
Package Drawing

TO-251



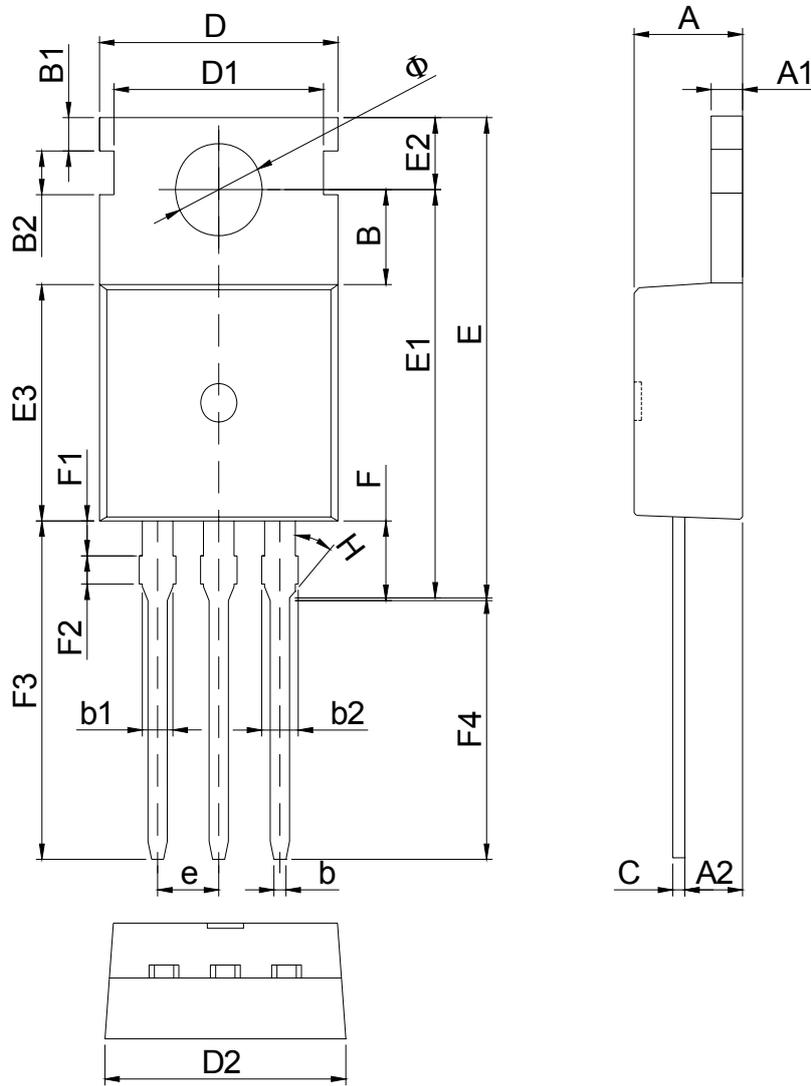
Symbol	Dimensions In Millimeters			Dimensions In Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.22	2.32	2.42	0.087	0.091	0.095
A1	0.89	1.02	1.140	0.035	0.040	0.045
b	0.55	0.61	0.67	0.022	0.024	0.026
b1	0.76	0.86	0.96	0.030	0.034	0.038
b2	5.20	5.30	5.40	0.205	0.209	0.213
c	0.46	0.52	0.57	0.018	0.020	0.022
c1	0.45	0.50	0.55	0.018	0.020	0.022
D	5.95	6.10	6.25	0.234	0.240	0.246
D1	4.20	4.35	4.50	0.165	0.171	0.177
E	6.40	6.55	6.70	0.252	0.258	0.264
E1	4.75	4.80	4.85	0.187	0.189	0.191
e	2.28REF			0.09REF		
L	8.90	9.20	9.50	0.350	0.362	0.374
L1	1.90	2.10	2.29	0.075	0.082	0.090
L2	0.90	0.95	1.00	0.035	0.037	0.039

TO-252



Symbol	Dimensions In Millimeters			Dimensions In Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.22	2.32	2.42	0.087	0.091	0.095
A1	-	-	0.125	-	-	0.005
b	0.55	0.61	0.67	0.022	0.024	0.026
b1	0.76	0.86	0.96	0.030	0.034	0.038
b2	5.20	5.30	5.40	0.205	0.209	0.213
c	0.45	0.50	0.55	0.018	0.020	0.022
D	5.95	6.10	6.25	0.234	0.240	0.246
D1	4.20	4.35	4.50	0.165	0.171	0.177
E	6.40	6.55	6.70	0.252	0.258	0.264
E1	4.75	4.80	4.85	0.187	0.189	0.191
e	2.28REF			0.09REF		
H	9.44	9.79	10.14	0.372	0.385	0.399
L	1.37	1.52	1.67	0.054	0.060	0.066
L1	2.75REF			0.108REF		
L2	0.50REF			0.020REF		
L3	0.90	0.95	1.00	0.035	0.037	0.039
L4	0.65	0.80	0.95	0.026	0.031	0.037
L5	1.14	1.33	1.52	0.045	0.052	0.060
Q	0°	-	6°	0°	-	6°

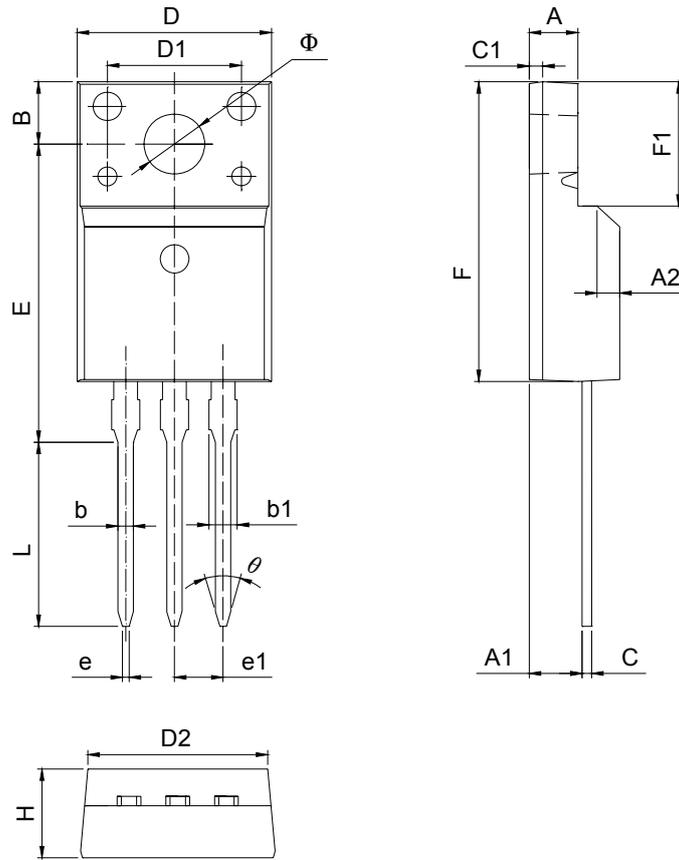
TO-220





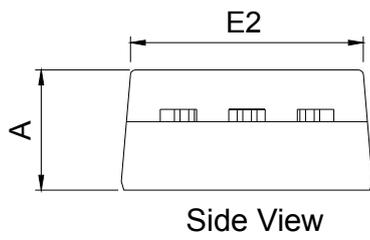
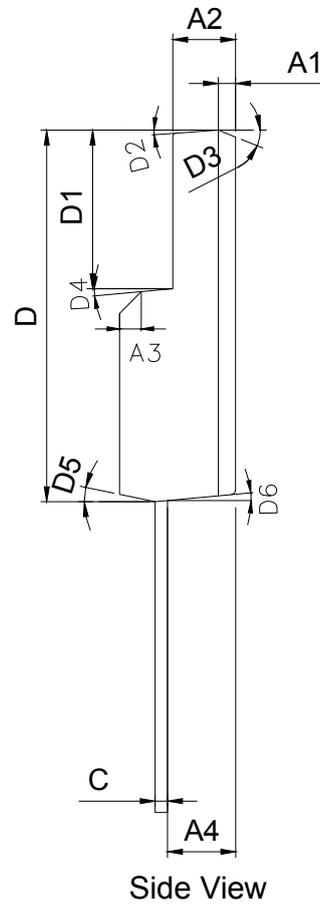
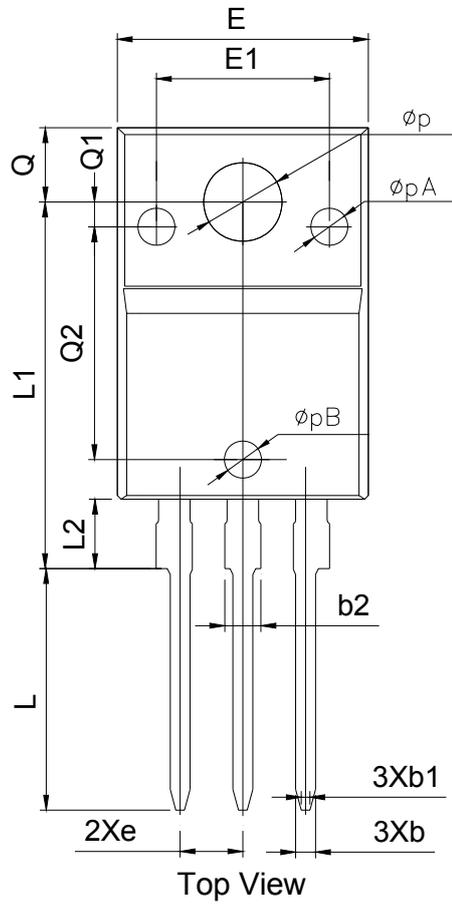
Symbol	Dimensions In Millimeters			Dimensions In Inches		
	Min	Nom	Max	Min	Nom	Max
<b>A</b>	4.45	4.50	4.55	0.175	0.177	0.179
<b>A1</b>	1.25	1.30	1.35	0.049	0.051	0.053
<b>A2</b>	2.20	2.40	2.60	0.087	0.094	0.102
<b>B</b>	-	3.70	-	-	0.146	-
<b>B1</b>	-	1.30	-	-	0.051	-
<b>B2</b>	-	1.70	-	-	0.067	-
<b>b</b>	0.70	0.80	0.90	0.028	0.031	0.035
<b>b1</b>	1.25	1.27	1.29	0.049	0.050	0.051
<b>b2</b>	1.42	1.52	1.62	0.056	0.060	0.064
<b>C</b>	0.45	0.50	0.55	0.018	0.020	0.022
<b>D</b>	9.85	9.90	9.95	0.388	0.390	0.392
<b>D1</b>	-	8.70	-	-	0.343	-
<b>D2</b>	9.98	10.00	10.02	0.393	0.394	0.394
<b>E</b>	-	-	18.95	-	-	0.746
<b>E1</b>	-	15.90	-	-	0.626	-
<b>E2</b>	-	2.80	-	-	0.110	-
<b>E3</b>	-	9.20	-	-	0.362	-
<b>e</b>	2.54 TYP			0.1 BSC		
<b>F</b>	-	3.00	-	-	0.118	-
<b>F1</b>	-	1.36	-	-	0.054	-
<b>F2</b>	-	1.10	-	-	0.043	-
<b>F3</b>	-	13.08	-	-	0.515	-
<b>F4</b>	10.03	10.08	10.13	0.395	0.397	0.399
<b>φ</b>	2.58	3.60	3.62	0.102	0.142	0.143
<b>H</b>	45°			45°		

TO-220F(A)



Symbol	Dimensions In Millimeters			Dimensions In Inches		
	Min	Nom	Max	Min	Nom	Max
A	-	2.54	-	-	0.100	-
A1	-	2.76	-	-	0.109	-
A2	1.10*45°			1.10*45°		
B	-	3.3	-	-	0.130	-
b	0.78	0.80	0.82	0.031	0.031	0.032
b1	-	-	1.45	-	-	0.057
C	0.48	0.50	0.52	0.019	0.020	0.020
C1	-	0.70	-	-	0.028	-
D	10.15	10.16	10.17	0.400	0.400	0.400
D1	-	7.00	-	-	0.276	-
D2	-	9.32	-	-	0.367	-
e1	2.54 TYP			0.1 BSC		
e	0.30	0.35	0.40	0.012	0.014	0.016
E	15.52	15.57	15.62	0.611	0.613	0.615
F	15.55	15.60	15.65	0.612	0.614	0.616
F1	-	6.68	-	-	0.263	-
L	9.75	9.80	9.85	0.384	0.386	0.388
H	4.55	4.60	4.65	0.179	0.181	0.183
$\phi$	3.19	3.24	3.29	0.126	0.128	0.130
$\theta$	30°			30°		

TO-220F(B)





Symbol	Dimensions In Millimeters			Dimensions In Inches		
	Min	Nom	Max	Min	Nom	Max
A	4.50	4.70	4.90	0.177	0.185	0.193
A1	-	0.70	-	-	0.028	-
A2	2.34	2.54	2.74	0.092	0.100	0.108
A3	-	-	-	-	-	-
A4	2.66	2.76	2.86	0.105	0.109	0.113
b	0.70	0.80	0.90	0.028	0.031	0.035
b1	0.25	0.35	0.45	0.010	0.014	0.018
b2	-	-	1.47	-	-	0.058
C	0.40	0.50	0.60	0.016	0.020	0.024
D	14.80	15.00	15.20	0.583	0.591	0.598
D1	6.20	6.40	6.60	0.244	0.252	0.260
D2	-	-	-	-	-	-
D3	-	-	-	-	-	-
D4	-	-	-	-	-	-
D5	-	-	-	-	-	-
D6	-	-	-	-	-	-
e	2.54 BSC			0.1 BSC		
E	9.96	10.16	10.36	0.392	0.400	0.408
E1	-	-	-	-	-	-
E2	9.26	9.46	9.66	0.365	0.372	0.380
L	9.55	9.75	9.95	0.376	0.384	0.392
L1	14.60	14.80	15.00	0.575	0.583	0.591
L2	2.60	2.80	3.00	0.102	0.110	0.118
Q	2.90	3.00	3.10	0.114	0.118	0.122
Q1	-	-	-	-	-	-
Q2	-	-	-	-	-	-
ØP	3.08	3.18	3.28	0.121	0.125	0.129
ØPA	-	-	-	-	-	-
ØPB	-	-	-	-	-	-



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